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Peng et al.

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(54) WIRELESS HEADSET

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CPC H04R 1/10; H04R 25/00; H04R 25/02; H04R 1/1066; H04R 1/1016; H04R 5/033; H04R 5/0335; H04R 1/1091; H04R 1/105

See application file for complete search history.

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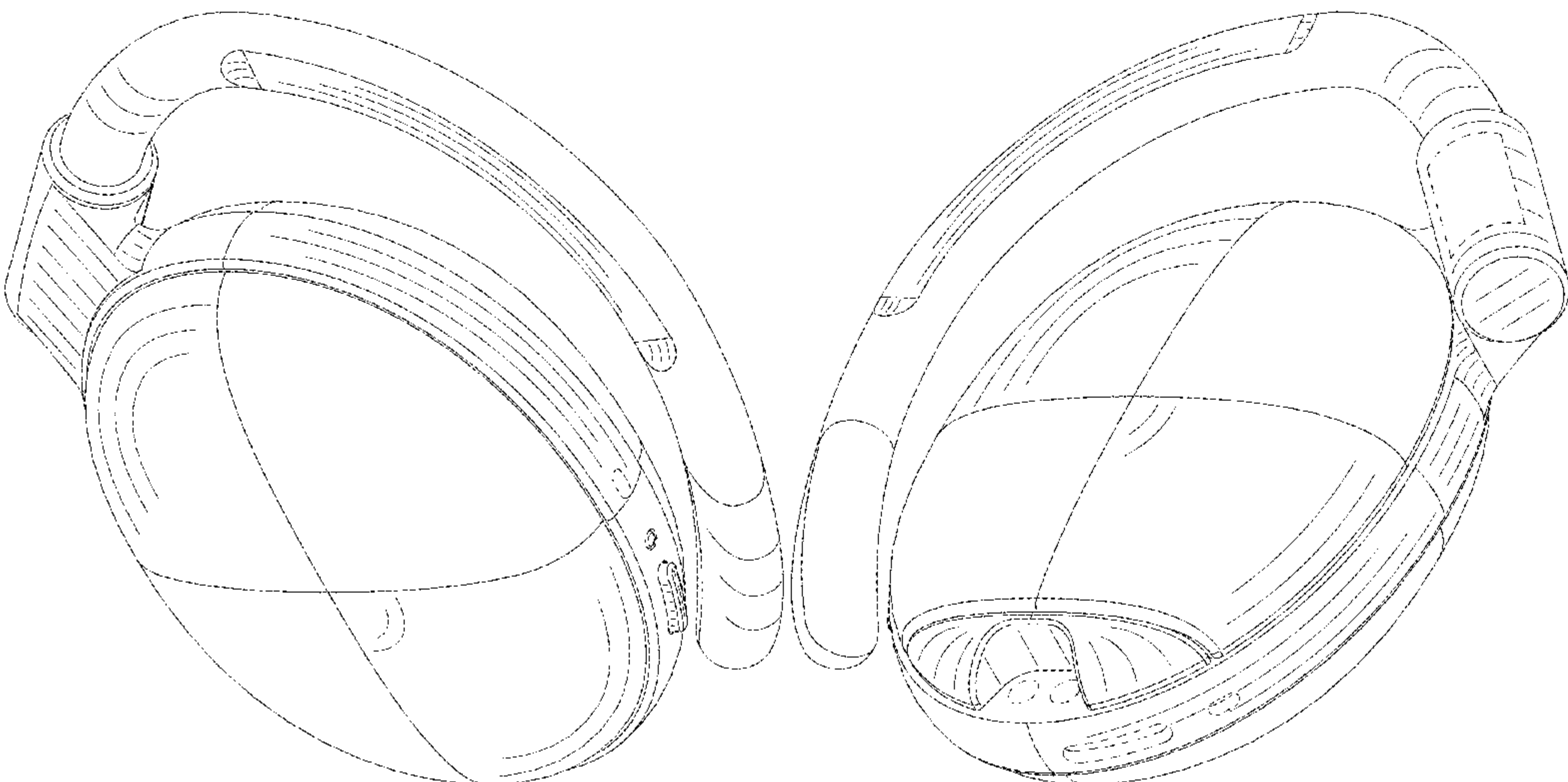
(57) CLAIM

The ornamental design for a wireless headset, as shown and described.

DESCRIPTION

FIG. 1 is a front perspective view of a wireless headset of the present disclosure;
FIG. 2 is a rear perspective view thereof;
FIG. 3 is a front elevational view thereof;
FIG. 4 is a rear elevational view thereof;
FIG. 5 is a left-side elevational view thereof;
FIG. 6 is a right-side elevational view thereof;
FIG. 7 is a top plan view thereof; and,
FIG. 8 is a bottom plan view thereof.
The broken lines shown in the drawings are for the purpose of illustrating portions of the wireless headset that form no part of the claimed design.

1 Claim, 8 Drawing Sheets



(56)

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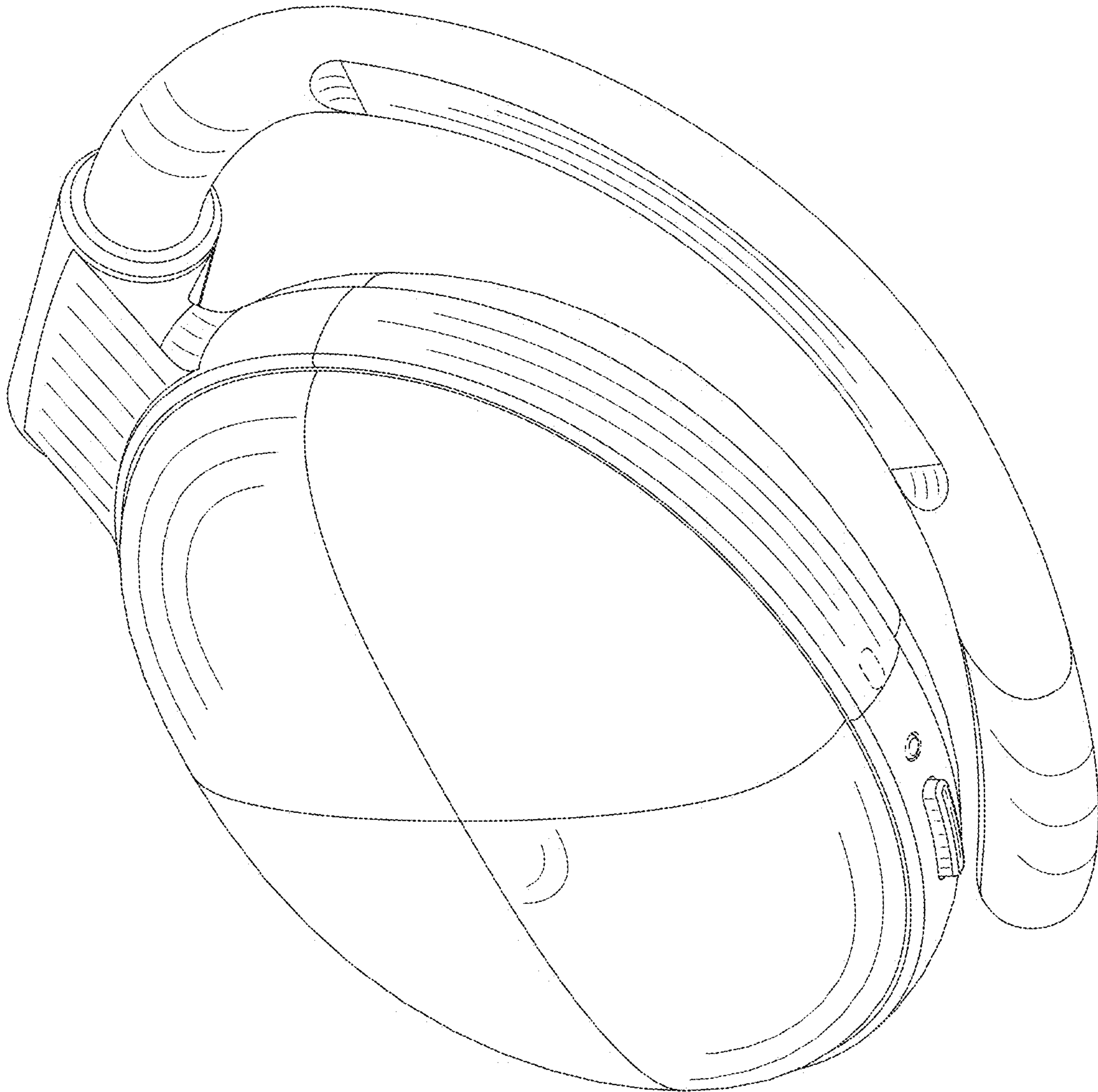


FIG. 1

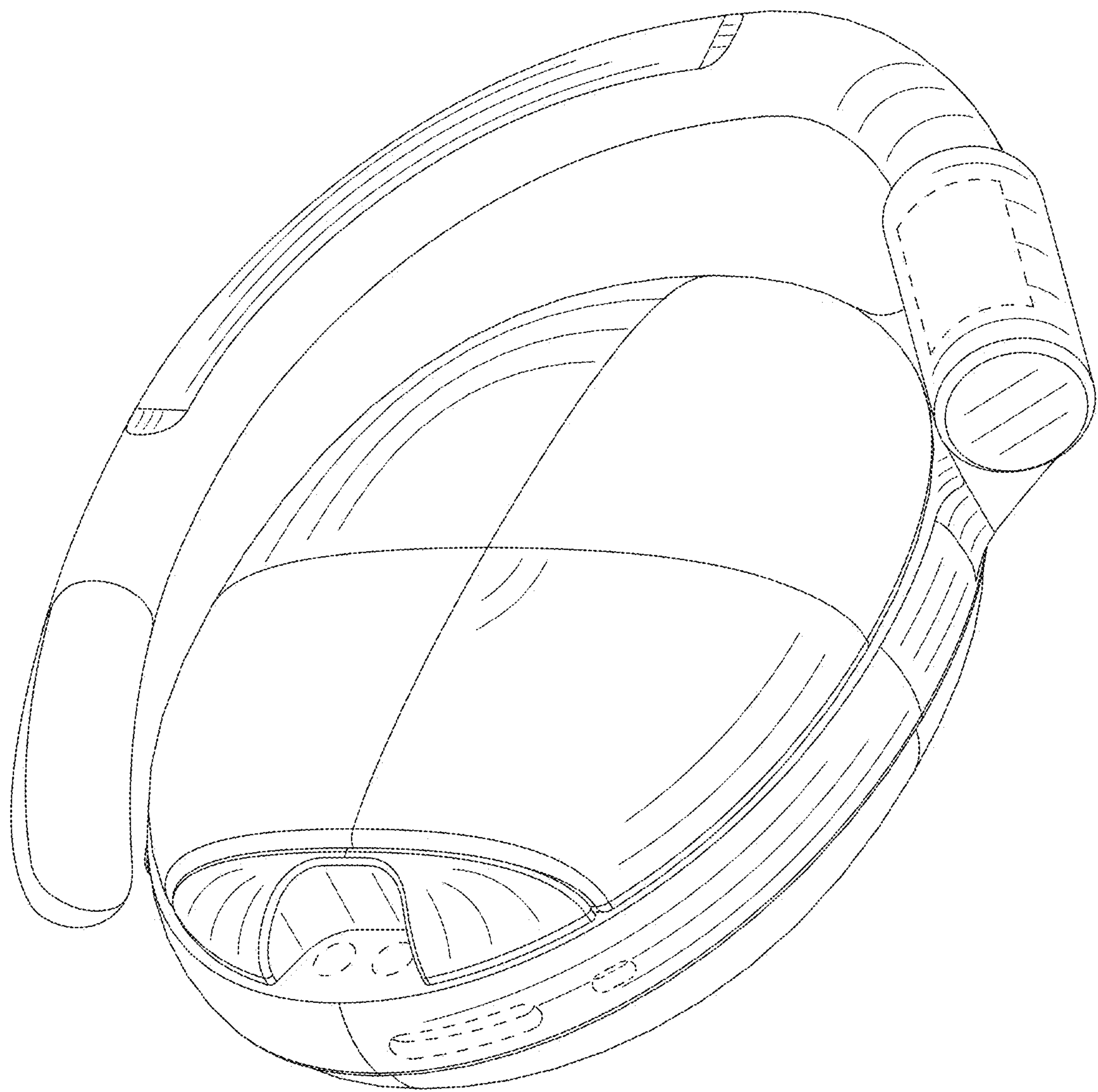


FIG.2

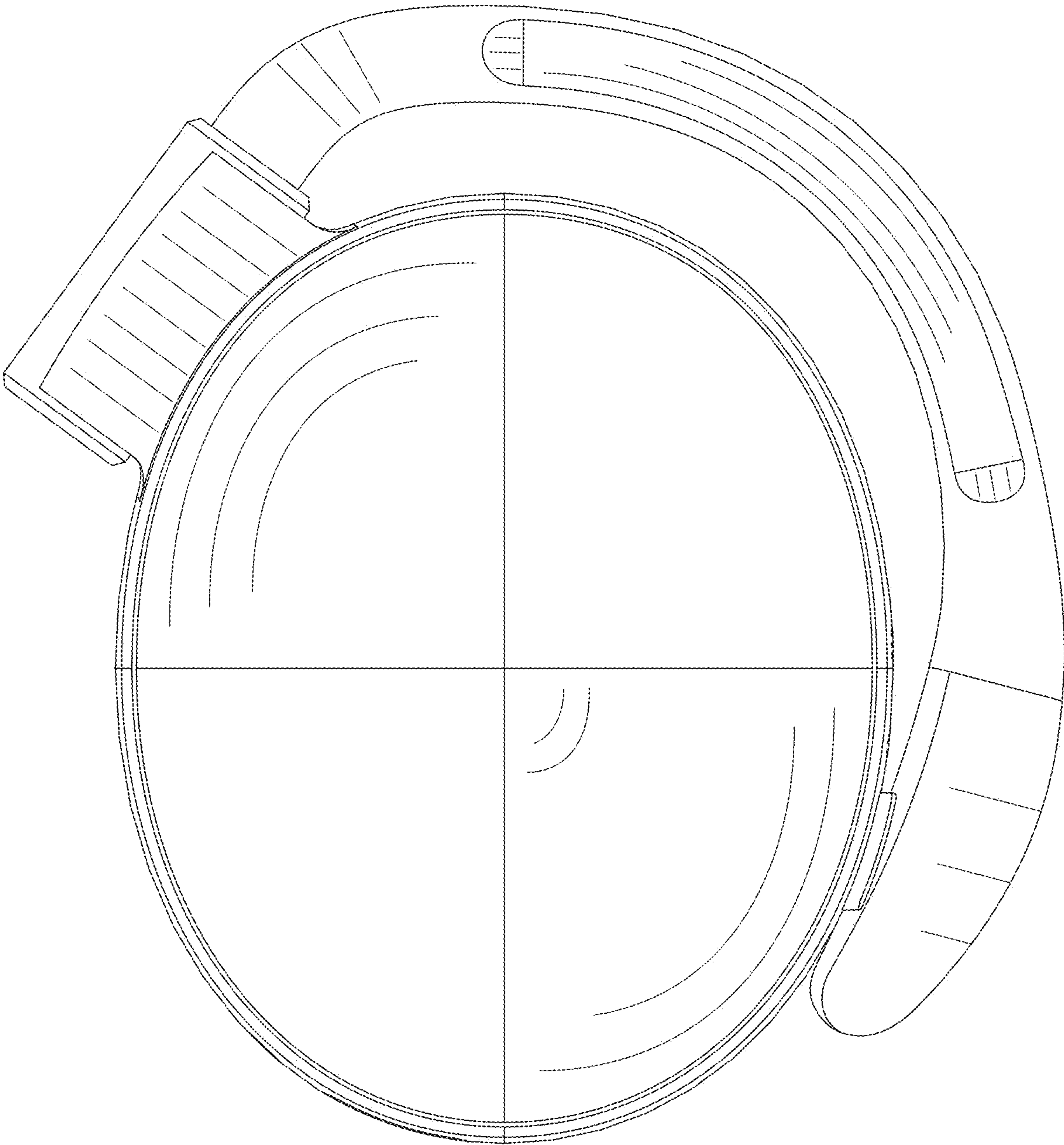


FIG.3

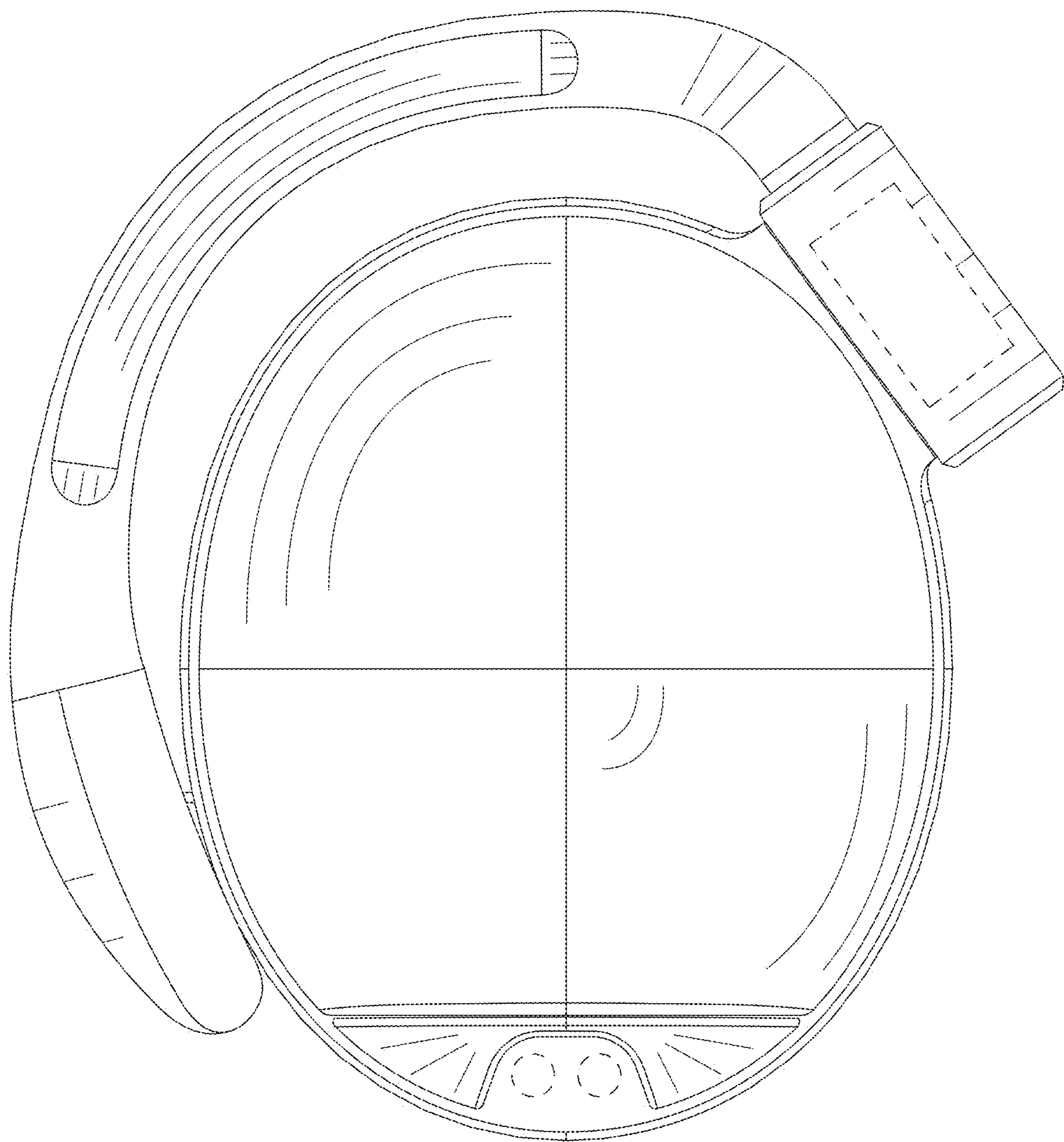


FIG.4

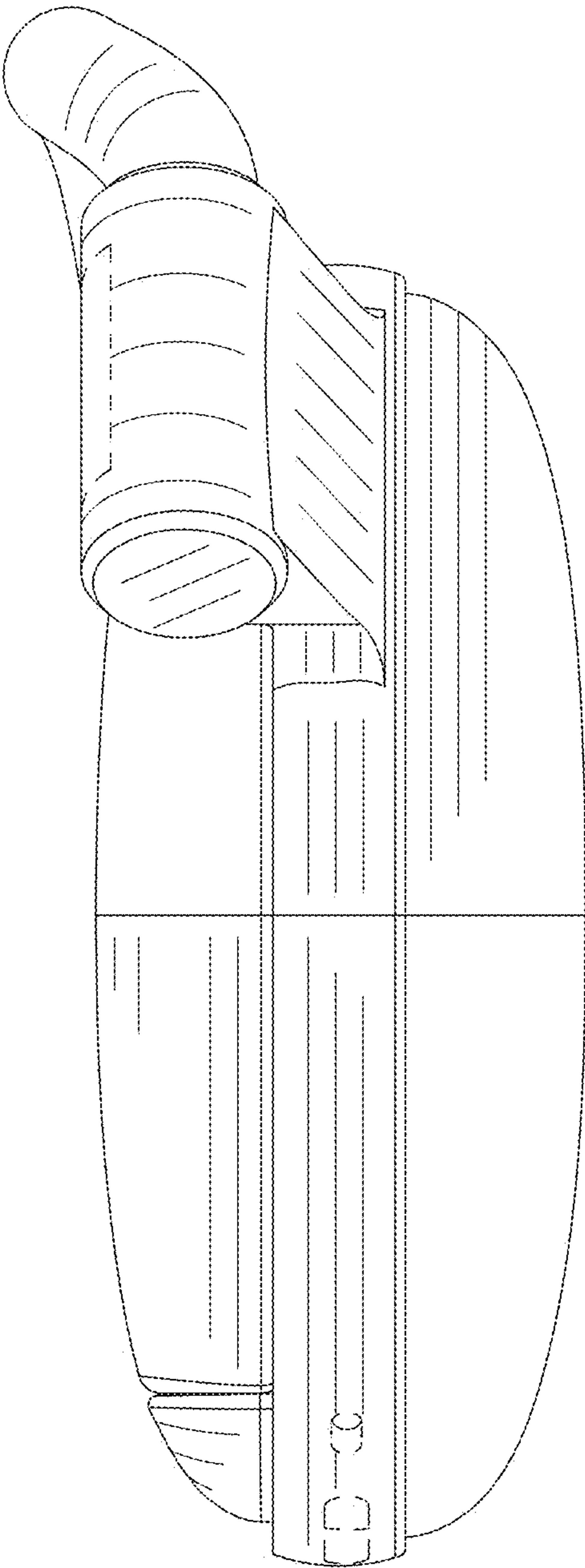


FIG.5

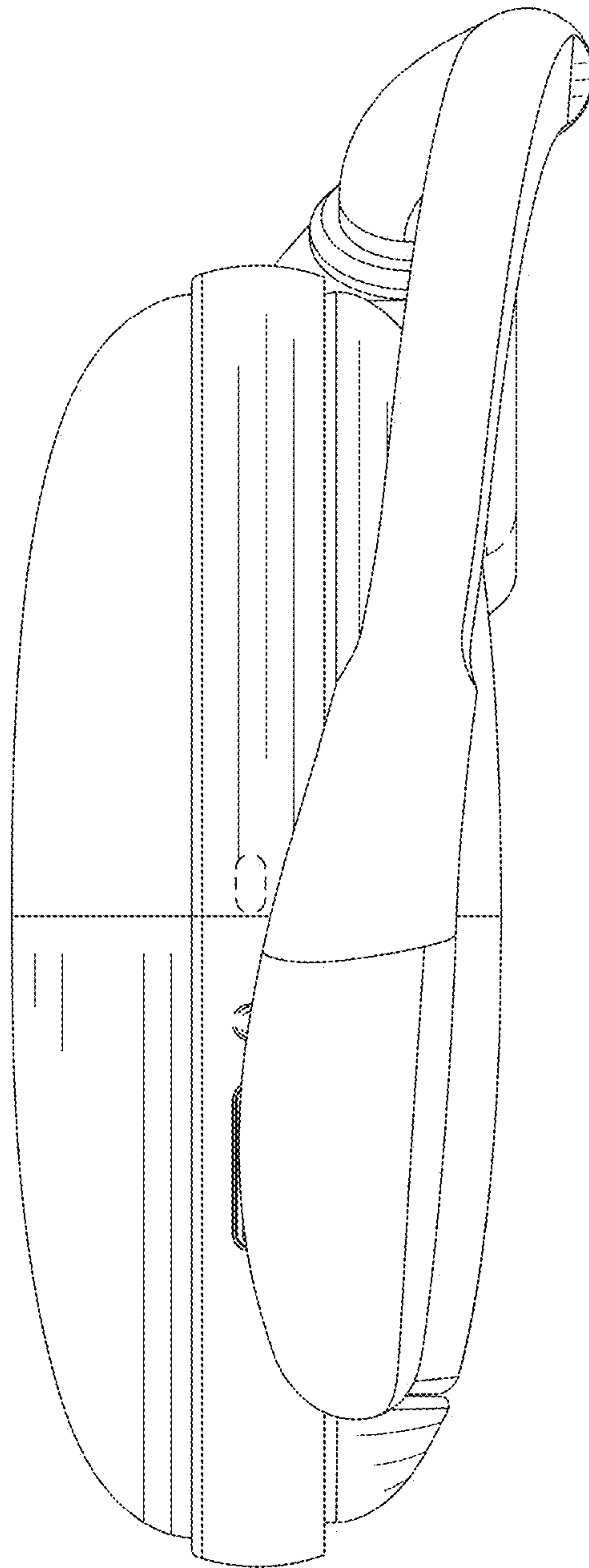


FIG.6

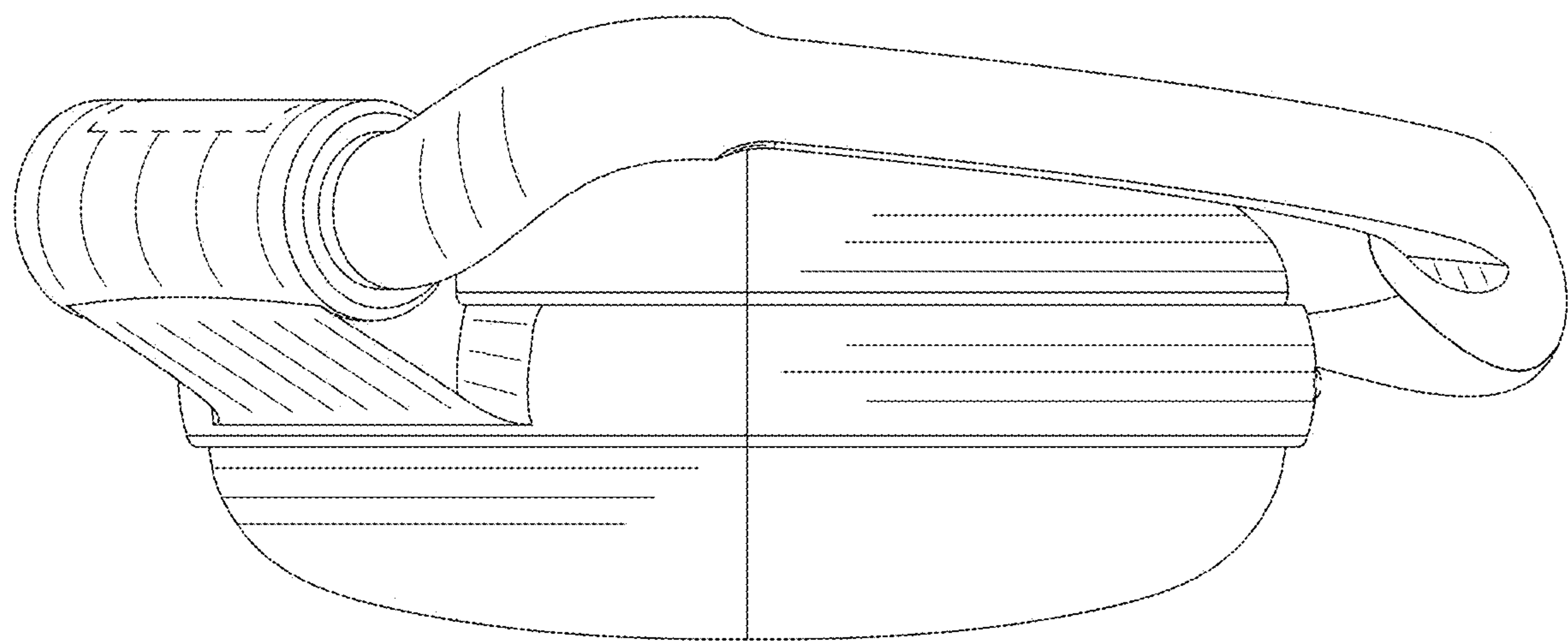


FIG.7

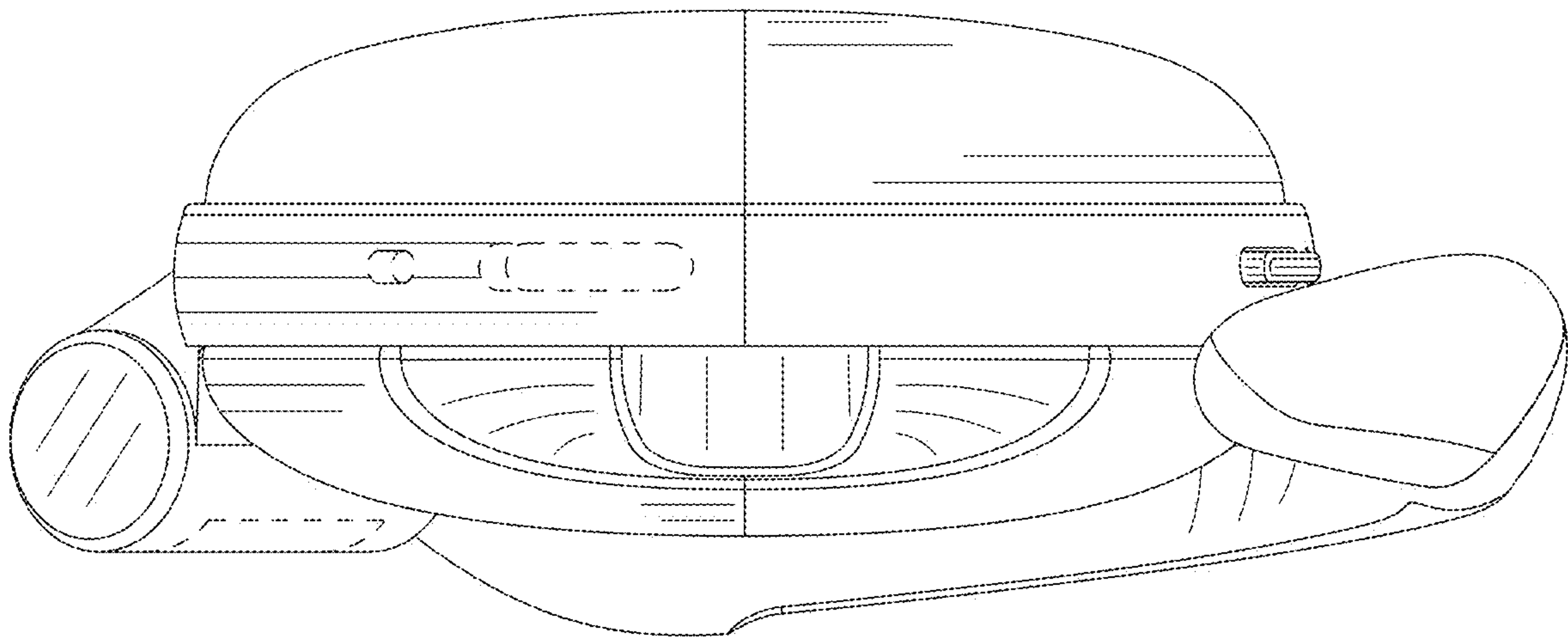


FIG. 8